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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

TOSHIO SHIOBARA, ET AL. : EXAMINER: FEELY, M.

SERIAL NO: 10/713,163 :

FILED: NOVEMBER 17, 2003 : GROUP ART UNIT: 1712

FOR: WAFER DICING/DIE BONDING  
SHEET :

AMENDMENT

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated February 27, 2006, please amend the application identified above as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.